### 501835581 02/28/2012

#### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Takeshi Kumazawa	11/09/2009
Yoshiyuki Sensui	11/09/2009
Toru Honda	11/09/2009

## RECEIVING PARTY DATA

Name:	MINO CERAMIC Co., Ltd.
Street Address:	719 Terakawado-cho, Mizunami-shi
City:	Gifu
State/Country:	JAPAN
Postal Code:	509-6121

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13407471

## **CORRESPONDENCE DATA**

Fax Number: (703)652-5101 Phone: 703-778-6607

Email: mkishimoto@kviplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

Correspondent Name: KENEALY VAIDYA LLP

Address Line 1: 515 EAST BRADDOCK RD SUITE B

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: 3030-0053DIV

NAME OF SUBMITTER: Ajit J. Vaidya

**Total Attachments: 2** 

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PATENT REEL: 027777 FRAME: 0857 OP \$40.00 13407471

#### ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

# DENSE BORON CARBIDE CERAMIC AND PROCESS FOR PRODUCING THE SAME

for which WE filed international application PCT/ JP2008/060964 on June 16, 2008 and for which we executed an application for United States Letters Patent concurrently herewith; and

WHEREAS MINO CERAMIC Co., Ltd. whose post office address is 719, Terakawado-cho, Mizunami-shi, Gifu 509-6121, Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged. WE, as assignors, have sold, assigned, transferred, and set over, and de hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authoria	se and request the attorneys WE has	e empowered in the Declaration	and Power of Attorney in
this application, to insert here in paren	theses (Application No	, filed	) the filing date
and application number of said applica	tion when known.		

IN TESTIMONY WHEREOF, I have hereunto set my hand.

<u>Full Name of First Assignor</u> KUMAZAWA, Takeshi	Assignor's Signatu	e - (clark	Date Najember, 9,2009	
Address: c/o MINO CERAMIC Co., Ltd., Technical Research Laboratory, 1-46, Kamezaki Kitaura-cho, Handa-Shi, Aichi 475-0027, Japan			<u>Citizenship</u> Japan	
Names of additional inventors attached [X Yes []No				

Cermak Kenealy Vaidya & Nakajima Lu-

PATENT REEL: 027777 FRAME: 0858

# ATTORNEY DOCKET NO.:

U.S. Patent Application No.:

Page 2 of 2

Full Name of Second Assignor SENSUI, Yoshiyuki	Assignor's Signature Sensui Joshiyuki	Date November 9, 2009
Address: c/o MINO CERAMIC Co., Ltd., Technical Resear Kitaura-cho, Handa-Shi, Aichi 475-0027, Japan	<u>Citizenship</u> : Japan	
Full Name of Third Assignor HONDA, Toru	Assignor's Signature Honda Tann	Date Wavember 9. 2009
Address: c/o MINO CERAMIC Co., Ltd., Technical Research Laboratory, 1-46, Kamezaki Kitaura-cho, Handa-Shi, Aichi 475-0027, Japan		<u>Citizenship</u> : Japan
Full Name of Fourth Assignor	Assignor's Signature	<u>Date</u>
Address:		<u>Citizenship:</u> Japan
Full Name of Fifth Assignor	Assignor's Signature	Date
Address:		<u>Citizenship:</u> Japan
Full Name of Sixth Assignor	Assignor's Signature	Date
Address		<u>Citizenship</u> Japan
Names of additional inventors attached     Yes   X   No		

Cermak Kenealy Vaidya & Nakajima LLP

PATENT REEL: 027777 FRAME: 0859

**RECORDED: 02/28/2012**